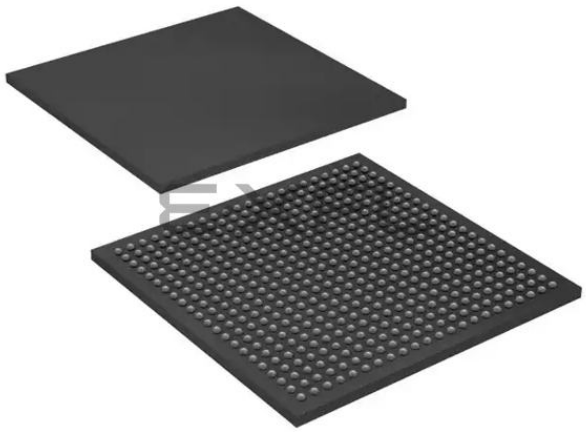

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

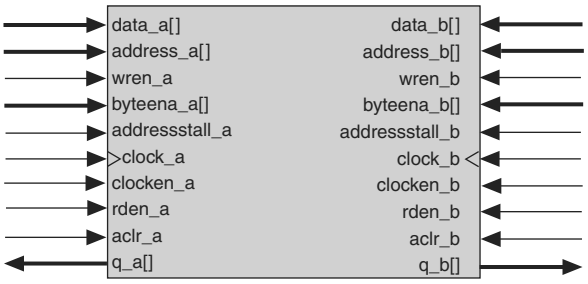
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	2475
Number of Logic Elements/Cells	39600
Total RAM Bits	1161216
Number of I/O	328
Number of Gates	-
Voltage - Supply	1.15V ~ 1.25V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BGA
Supplier Device Package	484-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep4ce40f23i7

True Dual-Port Mode

True dual-port mode supports any combination of two-port operations: two reads, two writes, or one read and one write, at two different clock frequencies. Figure 3–10 shows Cyclone IV devices true dual-port memory configuration.

Figure 3–10. Cyclone IV Devices True Dual-Port Memory *(1)*



Note to Figure 3–10:

(1) True dual-port memory supports input or output clock mode in addition to the independent clock mode shown.

☞ The widest bit configuration of the M9K blocks in true dual-port mode is 512 × 16-bit (18-bit with parity).

Table 3–4 lists the possible M9K block mixed-port width configurations.

Table 3–4. Cyclone IV Devices M9K Block Mixed-Width Configurations (True Dual-Port Mode)

Read Port	Write Port						
	8192 × 1	4096 × 2	2048 × 4	1024 × 8	512 × 16	1024 × 9	512 × 18
8192 × 1	✓	✓	✓	✓	✓	—	—
4096 × 2	✓	✓	✓	✓	✓	—	—
2048 × 4	✓	✓	✓	✓	✓	—	—
1024 × 8	✓	✓	✓	✓	✓	—	—
512 × 16	✓	✓	✓	✓	✓	—	—
1024 × 9	—	—	—	—	—	✓	✓
512 × 18	—	—	—	—	—	✓	✓

In true dual-port mode, M9K memory blocks support separate `wren` and `rden` signals. You can save power by keeping the `rden` signal low (inactive) when not reading. Read-during-write operations to the same address can either output "New Data" at that location or "Old Data". To choose the desired behavior, set the **Read-During-Write** option to either **New Data** or **Old Data** in the RAM MegaWizard Plug-In Manager in the Quartus II software. For more information about this behavior, refer to "Read-During-Write Operations" on page 3–15.

Clocking Modes

Cyclone IV devices M9K memory blocks support the following clocking modes:

- Independent
- Input or output
- Read or write
- Single-clock

When using read or write clock mode, if you perform a simultaneous read or write to the same address location, the output read data is unknown. If you require the output data to be a known value, use either single-clock mode or I/O clock mode and choose the appropriate read-during-write behavior in the MegaWizard Plug-In Manager.

Violating the setup or hold time on the memory block input registers might corrupt the memory contents. This applies to both read and write operations.

Asynchronous clears are available on read address registers, output registers, and output latches only.

Table 3–5 lists the clocking mode versus memory mode support matrix.

Table 3–5. Cyclone IV Devices Memory Clock Modes

Clocking Mode	True Dual-Port Mode	Simple Dual-Port Mode	Single-Port Mode	ROM Mode	FIFO Mode
Independent	✓	—	—	✓	—
Input or output	✓	✓	✓	✓	—
Read or write	—	✓	—	—	✓
Single-clock	✓	✓	✓	✓	✓

Independent Clock Mode

Cyclone IV devices M9K memory blocks can implement independent clock mode for true dual-port memories. In this mode, a separate clock is available for each port (port A and port B). `clock A` controls all registers on the port A side, while `clock B` controls all registers on the port B side. Each port also supports independent clock enables for port A and B registers.

Input or Output Clock Mode

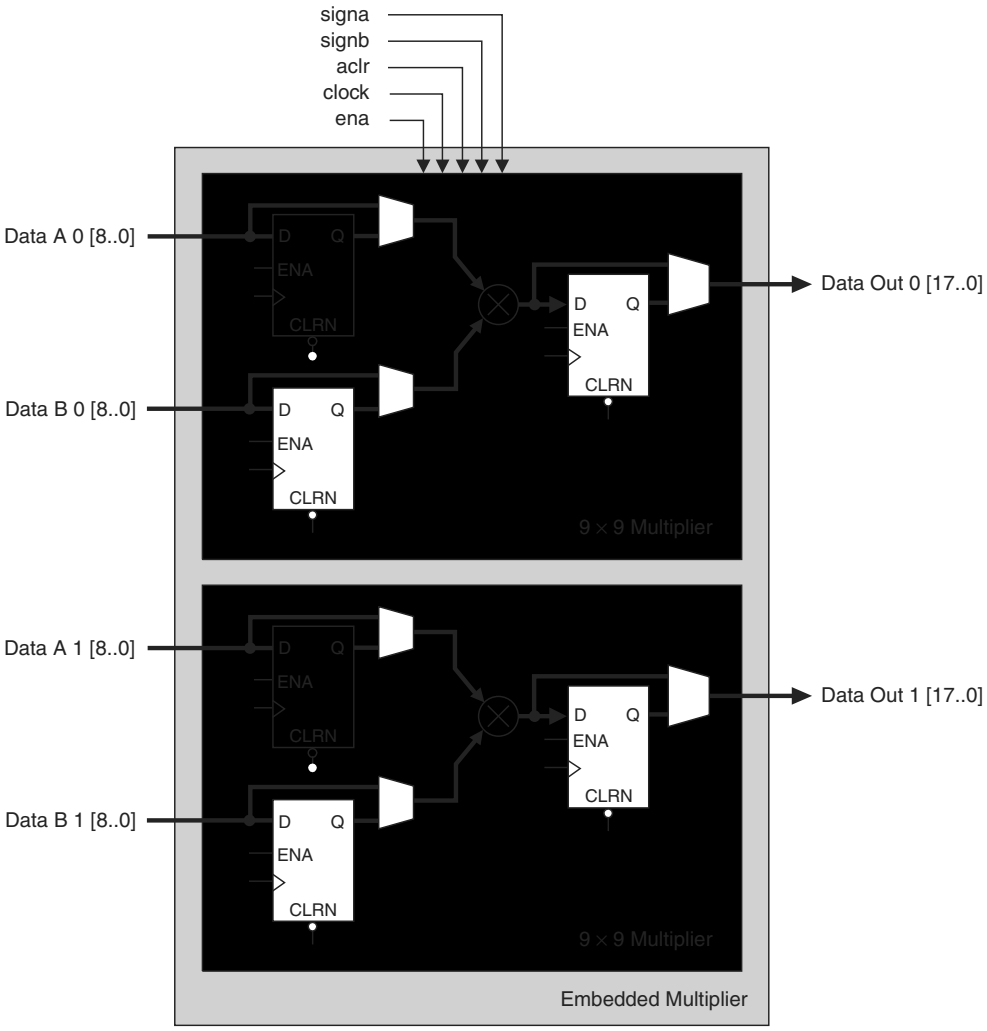
Cyclone IV devices M9K memory blocks can implement input or output clock mode for FIFO, single-port, true, and simple dual-port memories. In this mode, an input clock controls all input registers to the memory block including data, address, `byteena`, `wren`, and `rden` registers. An output clock controls the data-output registers. Each memory block port also supports independent clock enables for input and output registers.

9-Bit Multipliers

You can configure each embedded multiplier to support two 9 × 9 independent multipliers for input widths of up to 9 bits.

Figure 4–4 shows the embedded multiplier configured to support two 9-bit multipliers.

Figure 4–4. 9-Bit Multiplier Mode



All 9-bit multiplier inputs and results are independently sent through registers. The multiplier inputs can accept signed integers, unsigned integers, or a combination of both. Two 9 × 9 multipliers in the same embedded multiplier block share the same `signa` and `signb` signal. Therefore, all the `Data A` inputs feeding the same embedded multiplier must have the same sign representation. Similarly, all the `Data B` inputs feeding the same embedded multiplier must have the same sign representation.

Figure 6–16. RSDS, Mini-LVDS, or PPDS Interface with External Resistor Network on the Top and Bottom I/O Banks *(1)*

Note to Figure 6–16:

(1) R_S and R_P values are pending characterization.

A resistor network is required to attenuate the output voltage swing to meet RSDS, mini-LVDS, and PPDS specifications when using emulated transmitters. You can modify the resistor network values to reduce power or improve the noise margin.

The resistor values chosen must satisfy Equation 6–1.

Equation 6–1. Resistor Network

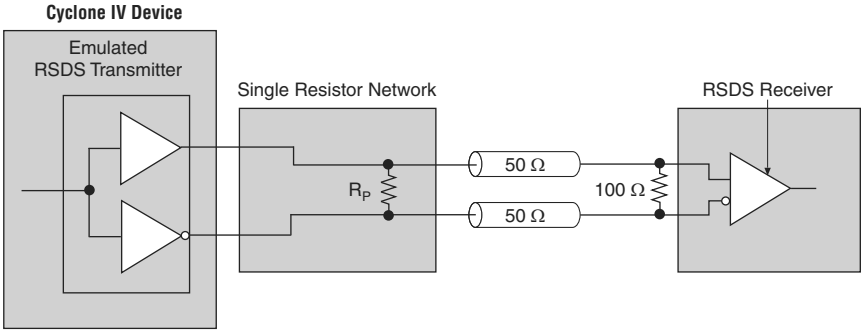
$$\frac{R_S \times \frac{R_P}{2}}{R_S + \frac{R_P}{2}} = 50\ \Omega$$

Altera recommends that you perform simulations using Cyclone IV devices IBIS models to validate that custom resistor values meet the RSDS, mini-LVDS, or PPDS requirements.

It is possible to use a single external resistor instead of using three resistors in the resistor network for an RSDS interface, as shown in Figure 6–17. The external single-resistor solution reduces the external resistor count while still achieving the required signaling level for RSDS. However, the performance of the single-resistor solution is lower than the performance with the three-resistor network.

Figure 6–17 shows the RSDS interface with a single resistor network on the top and bottom I/O banks.

Figure 6–17. RSDS Interface with Single Resistor Network on the Top and Bottom I/O Banks *(1)*



Note to Figure 6–17:

(1) R_P value is pending characterization.

Board Design Considerations

This section explains how to achieve the optimal performance from a Cyclone IV I/O interface and ensure first-time success in implementing a functional design with optimal signal quality. You must consider the critical issues of controlled impedance of traces and connectors, differential routing, and termination techniques to get the best performance from Cyclone IV devices.

Use the following general guidelines to improve signal quality:

- Base board designs on controlled differential impedance. Calculate and compare all parameters, such as trace width, trace thickness, and the distance between two differential traces.
- Maintain equal distance between traces in differential I/O standard pairs as much as possible. Routing the pair of traces close to each other maximizes the common-mode rejection ratio (CMRR).
- Longer traces have more inductance and capacitance. These traces must be as short as possible to limit signal integrity issues.
- Place termination resistors as close to receiver input pins as possible.
- Use surface mount components.
- Avoid 90° corners on board traces.
- Use high-performance connectors.
- Design backplane and card traces so that trace impedance matches the impedance of the connector and termination.
- Keep an equal number of vias for both signal traces.
- Create equal trace lengths to avoid skew between signals. Unequal trace lengths result in misplaced crossing points and decrease system margins as the TCCS value increases.
- Limit vias because they cause discontinuities.
- Keep switching transistor-to-transistor logic (TTL) signals away from differential signals to avoid possible noise coupling.
- Do not route TTL clock signals to areas under or above the differential signals.
- Analyze system-level signals.

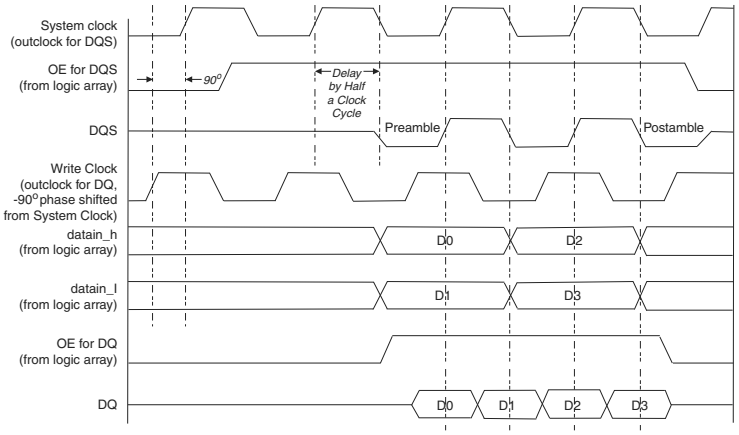
For PCB layout guidelines, refer to *AN 224: High-Speed Board Layout Guidelines* and *AN 315: Guidelines for Designing High-Speed FPGA PCBs.*

Software Overview

Cyclone IV devices high-speed I/O system interfaces are created in core logic by a Quartus II software megafunction because they do not have a dedicated circuit for the SERDES. Cyclone IV devices use the I/O registers and LE registers to improve the timing performance and support the SERDES. The Quartus II software allows you to design your high-speed interfaces using ALTLVDS megafunction. This megafunction

Figure 7–9 illustrates how the second output enable register extends the DQS high-impedance state by half a clock cycle during a write operation.

Figure 7–9. Extending the OE Disable by Half a Clock Cycle for a Write Transaction *(1)*



Note to Figure 7–9:

(1) The waveform reflects the software simulation result. The OE signal is an active low on the device. However, the Quartus II software implements the signal as an active high and automatically adds an inverter before the A_{OE} register D input.

OCT with Calibration

Cyclone IV devices support calibrated on-chip series termination (R_S OCT) in both vertical and horizontal I/O banks. To use the calibrated OCT, you must use the RUP and RDN pins for each R_S OCT control block (one for each side). You can use each OCT calibration block to calibrate one type of termination with the same V_{CCIO} for that given side.

For more information about the Cyclone IV devices OCT calibration block, refer to the *Cyclone IV Device I/O Features* chapter.

PLL

When interfacing with external memory, the PLL is used to generate the memory system clock, the write clock, the capture clock and the logic-core clock. The system clock generates the DQS write signals, commands, and addresses. The write-clock is shifted by -90° from the system clock and generates the DQ signals during writes. You can use the PLL reconfiguration feature to calibrate the read-capture phase shift to balance the setup and hold margins.

The PLL is instantiated in the ALTMEMPHY megafunction. All outputs of the PLL are used when the ALTMEMPHY megafunction is instantiated to interface with external memories. PLL reconfiguration is used in the ALTMEMPHY megafunction to calibrate and track the read-capture phase to maintain the optimum margin.

For more information about usage of PLL outputs by the ALTMEMPHY megafunction, refer to the *External Memory Interface Handbook*.

Table 8–4. Configuration Schemes for Cyclone IV GX Devices (EP4CGX30 [only for F484 package], EP4CGX50, EP4CGX75, EP4CGX110, and EP4CGX150) (Part 2 of 2)

Configuration Scheme	MSEL3	MSEL2	MSEL1	MSEL0	POR Delay	Configuration Voltage Standard (V) (1)
JTAG-based configuration (2)	(3)	(3)	(3)	(3)	—	—

Notes to Table 8–4:

(1) Configuration voltage standard applied to the V_{CCIO} supply of the bank in which the configuration pins reside.

(2) JTAG-based configuration takes precedence over other configuration schemes, which means the MSEL pin settings are ignored.

(3) Do not leave the MSEL pins floating. Connect them to V_{CCA} or GND. These pins support the non-JTAG configuration scheme used in production. Altera recommends connecting the MSEL pins to GND if your device is only using JTAG configuration.

Smaller Cyclone IV E devices or package options (E144 and F256 packages) do not have the MSEL[3] pin. The AS Fast POR configuration scheme at 3.0- or 2.5-V configuration voltage standard and the AP configuration scheme are not supported in Cyclone IV E devices without the MSEL[3] pin. To configure these devices with other supported configuration schemes, select MSEL[2..0] pins according to the MSEL settings in Table 8–5.

Table 8–5. Configuration Schemes for Cyclone IV E Devices

Configuration Scheme	MSEL3	MSEL2	MSEL1	MSEL0	POR Delay	Configuration Voltage Standard (V) (1)
AS	1	1	0	1	Fast	3.3
	0	1	0	0	Fast	3.0, 2.5
	0	0	1	0	Standard	3.3
	0	0	1	1	Standard	3.0, 2.5
AP	0	1	0	1	Fast	3.3
	0	1	1	0	Fast	1.8
	0	1	1	1	Standard	3.3
	1	0	1	1	Standard	3.0, 2.5
	1	0	0	0	Standard	1.8
PS	1	1	0	0	Fast	3.3, 3.0, 2.5
	0	0	0	0	Standard	3.3, 3.0, 2.5
FPP	1	1	1	0	Fast	3.3, 3.0, 2.5
	1	1	1	1	Fast	1.8, 1.5
JTAG-based configuration (2)	(3)	(3)	(3)	(3)	—	—

Notes to Table 8–5:

(1) Configuration voltage standard applied to the V_{CCIO} supply of the bank in which the configuration pins reside.

(2) JTAG-based configuration takes precedence over other configuration schemes, which means the MSEL pin settings are ignored.

(3) Do not leave the MSEL pins floating. Connect them to V_{CCA} or GND. These pins support the non-JTAG configuration scheme used in production. Altera recommends connecting the MSEL pins to GND if your device is only using JTAG configuration.

devices. The internal oscillator is designed to ensure that its maximum frequency is guaranteed to meet EPCS device specifications. Cyclone IV devices offer the option to select CLKUSR as the external clock source for DCLK. You can change the clock source option in the Quartus II software in the **Configuration** tab of the **Device and Pin Options** dialog box.

EPCS1 does not support Cyclone IV devices because of its insufficient memory capacity.

Table 8–6. AS DCLK Output Frequency

Oscillator	Minimum	Typical	Maximum	Unit
40 MHz	20	30	40	MHz

In configuration mode, the Cyclone IV device enables the serial configuration device by driving the nCSO output pin low, which connects to the nCS pin of the configuration device. The Cyclone IV device uses the DCLK and DATA[1] pins to send operation commands and read address signals to the serial configuration device. The configuration device provides data on its DATA pin, which connects to the DATA[0] input of the Cyclone IV device.

All AS configuration pins (DATA[0], DCLK, nCSO, and DATA[1]) have weak internal pull-up resistors that are always active. After configuration, these pins are set as input tri-stated and are driven high by the weak internal pull-up resistors.

The timing parameters for AS mode are not listed here because the t_{CF2CD}, t_{CF2ST0}, t_{CFG}, t_{STATUS}, t_{CF2ST1}, and t_{CD2UM} timing parameters are identical to the timing parameters for PS mode shown in Table 8–12 on page 8–36.

Section I. Transceivers

This section provides a complete overview of all features relating to the Cyclone® IV device transceivers. This section includes the following chapters:

- Chapter 1, Cyclone IV Transceivers Architecture
- Chapter 2, Cyclone IV Reset Control and Power Down
- Chapter 3, Cyclone IV Dynamic Reconfiguration

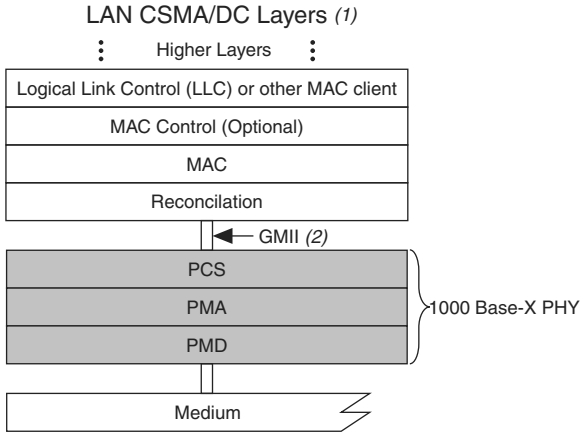
Revision History

Refer to the chapter for its own specific revision history. For information about when the chapter was updated, refer to the Chapter Revision Dates section, which appears in the complete handbook.

Cyclone IV GX transceivers do not have built-in support for some PCS functions such as auto-negotiation state machine, collision-detect, and carrier-sense. If required, you must implement these functions in a user logic or external circuits.

The 1000 Base-X PHY is defined by IEEE 802.3 standard as an intermediate or transition layer that interfaces various physical media with the media access control (MAC) in a GbE system. The 1000 Base-X PHY, which has a physical interface data rate of 1.25 Gbps consists of the PCS, PMA, and physical media dependent (PMD) layers. Figure 1–54 shows the 1000 Base-X PHY in LAN layers.

Figure 1–54. 1000 Base-X PHY in a GbE OSI Reference Model



Notes to Figure 1–54:

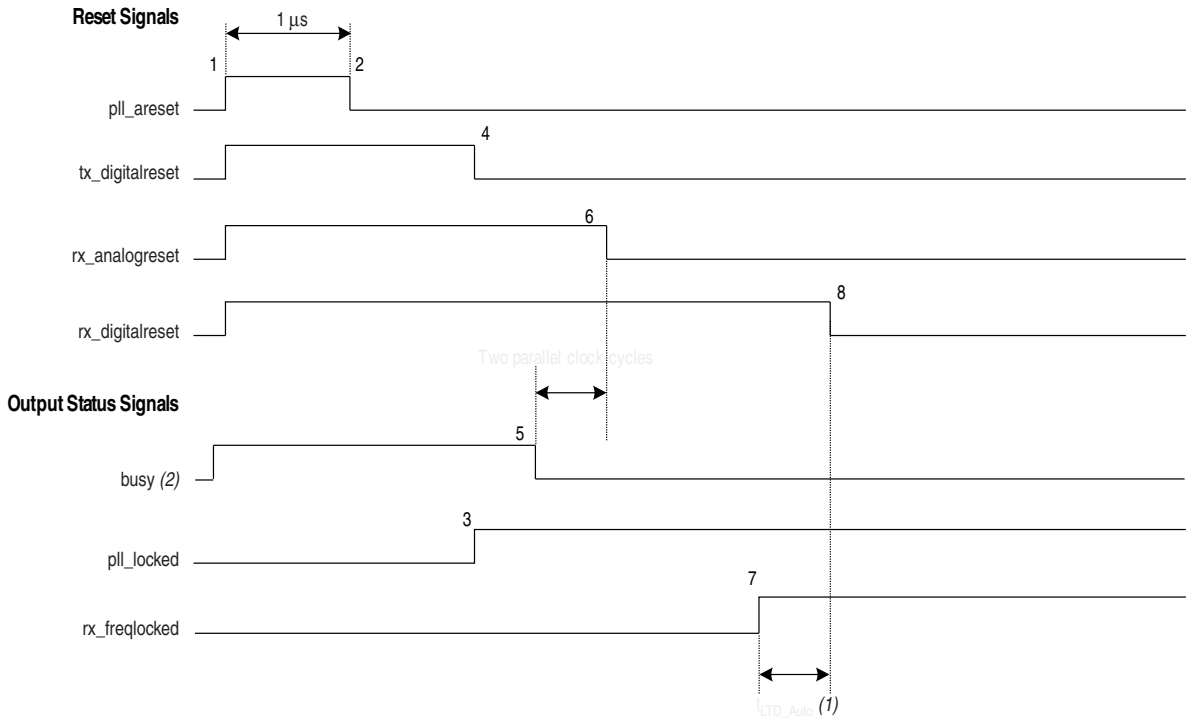
(1) CSMA/CD = Carrier-Sense Multiple Access with Collision Detection

(2) GMII = gigabit medium independent interface

Receiver and Transmitter Channel—Receiver CDR in Automatic Lock Mode

This configuration contains both a transmitter and a receiver channel. If you create a **Receiver and Transmitter** instance in the ALTGX MegaWizard Plug-In Manager with the receiver CDR in automatic lock mode, use the reset sequence shown in Figure 2–8.

Figure 2–8. Sample Reset Sequence of Receiver and Transmitter Channel—Receiver CDR in Automatic Lock Mode



Notes to Figure 2–8:

(1) For t_{LTD_Auto} duration, refer to the *Cyclone IV Device Datasheet* chapter.

(2) The `busy` signal is asserted and deasserted only during initial power up when offset cancellation occurs. In subsequent reset sequences, the `busy` signal is asserted and deasserted only if there is a read or write operation to the ALTGX_RECONFIG megafunction.

As shown in Figure 2–8, perform the following reset procedure for the receiver in CDR automatic lock mode:

1. After power up, assert `pll_areset` for a minimum period of 1 µs (the time between markers 1 and 2).
2. Keep the `tx_digitalreset`, `rx_analogreset`, and `rx_digitalreset` signals asserted during this time period. After you deassert the `pll_areset` signal, the multipurpose PLL starts locking to the transmitter input reference clock.
3. After the multipurpose PLL locks, as indicated by the `pll_locked` signal going high (marker 3), deassert `tx_digitalreset`. For receiver operation, after deassertion of busy signal, wait for two parallel clock cycles to deassert the `rx_analogreset` signal.
4. Wait for the `rx_freqlocked` signal to go high (marker 7).
5. After the `rx_freqlocked` signal goes high, wait for at least t_{LTD_Auto}, then deassert the `rx_digitalreset` signal (marker 8). At this point, the transmitter and receiver are ready for data traffic.

This solution may violate some of the protocol specific requirements. In such case, you can use Manual CDR lock option.

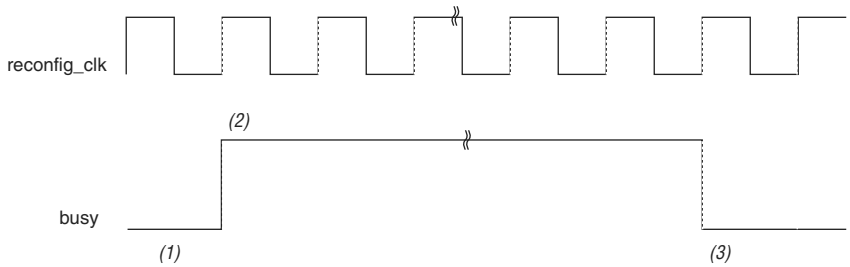
- For Manual CDR lock mode, `rx_freqlocked` signal is not available. Upon detection of a dead link, take the following steps:
  a. Switch to LTR mode.
  b. Assert `rx_digitalreset`.
  c. Wait for `rx_pll_locked` to go high.
  d. When you detect incoming data on the receive pins, switch to LTD mode.
  e. Wait for a duration of t_{LTD_Manual}, which is the time taken to recover valid data after the `rx_locktodata` signal is asserted in manual mode.
  f. De-assert `rx_digitalreset`.

Table 3–2. Dynamic Reconfiguration Controller Port List (ALTGX_RECONFIG Instance) (Part 6 of 7)

Port Name	Input/ Output	Description
rx_eqdcgain [1..0] (1)	Input	This is an optional equalizer DC gain write control. The width of this signal is fixed to 2 bits if you enable either the **Use 'logical_channel_address' port for Analog controls reconfiguration** option or the **Use same control signal for all the channels** option in the **Analog controls** screen. Otherwise, the width of this signal is 2 bits per channel. The following values are the legal settings allowed for this signal: rx_eqdcgain[1..0] — Corresponding ALTGX settings — Corresponding DC Gain value (dB) 2'b00 — 0 — 0 2'b01 — 1 — 3 (2) 2'b10 — 2 — 6 All other values => N/A For more information, refer to the "Programmable Equalization and DC Gain" section of the *Cyclone IV GX Device Datasheet* chapter.
tx_vodctrl_out [2..0]	Output	This is an optional transmit V_{OD} read control signal. This signal reads out the value written into the V_{OD} control register. The width of this output signal depends on the number of channels controlled by the dynamic reconfiguration controller and also the configuration of the **Use 'logical_channel_address' port for Analog controls reconfiguration** option and the **Use same control signal for all the channels** option.
tx_preemp_out [4..0]	Output	This is an optional pre-emphasis read control signal. This signal reads out the value written by its input control signal. The width of this output signal depends on the number of channels controlled by the dynamic reconfiguration controller and also the configuration of the **Use 'logical_channel_address' port for Analog controls reconfiguration** option and the **Use same control signal for all the channels** option.
rx_eqctrl_out [3..0]	Output	This is an optional read control signal to read the setting of equalization setting of the ALTGX instance. The width of this output signal depends on the number of channels controlled by the dynamic reconfiguration controller and also the configuration of the **Use 'logical_channel_address' port for Analog controls reconfiguration** option and the **Use same control signal for all the channels** option.
rx_eqdcgain_out [1..0]	Output	This is an optional equalizer DC gain read control signal. This signal reads out the settings of the ALTGX instance DC gain. The width of this output signal depends on the number of channels controlled by the dynamic reconfiguration controller and also the configuration of the **Use 'logical_channel_address' port for Analog controls reconfiguration** option and the **Use same control signal for all the channels** option.
Transceiver Channel Reconfiguration Control/Status Signals		
reconfig_mode_ sel[2..0] (3)	Input	Set the following values at this signal to activate the appropriate dynamic reconfiguration mode: 3'b000 = PMA controls reconfiguration mode. This is the default value. 3'b001 = Channel reconfiguration mode All other values => N/A reconfig_mode_sel[] is available as an input only when you enable more than one dynamic reconfiguration mode.

Figure 3–3 shows the timing diagram for a offset cancellation process.

Figure 3–3. Dynamic Reconfiguration Signals Transition during Offset Cancellation



Notes to Figure 3–3:

(1) After device power up, the busy signal remains low for the first reconfig_clk cycle.
(2) The busy signal then gets asserted for the second reconfig_clk cycle, when the dynamic reconfiguration controller initiates the offset cancellation process.
(3) The deassertion of the busy signal indicates the successful completion of the offset cancellation process.

Functional Simulation of the Offset Cancellation Process

You must connect the ALTGX_RECONFIG instances to the ALTGX instances in your design for functional simulation. Functional simulation uses a reduced timing model of the dynamic reconfiguration controller. Therefore, the duration of the offset cancellation process is 16 reconfig_clk clock cycles for functional simulation only. The gxb_powerdown signal must not be asserted during the offset cancellation sequence (for functional simulation and silicon).

Dynamic Reconfiguration Modes

When you enable the dynamic reconfiguration feature, you can reconfigure the following portions of each transceiver channel dynamically, without powering down the other transceiver channels or the FPGA fabric of the device:

- Analog (PMA) controls reconfiguration
- Channel reconfiguration
- PLL reconfiguration

Table 3–3 lists the supported dynamic reconfiguration modes for Cyclone IV GX devices.

Table 3–3. Cyclone IV GX Supported Dynamic Reconfiguration Mode (Part 1 of 2)

Dynamic Reconfiguration Supported Mode	Operational Mode			Quartus II Instances			.mif Requirements
	Transmitter Only	Receiver Only	Transmitter and Receiver Only	ALTGX	ALTGX_RECONFIG	ALTPLL_RECONFIG	
Offset Cancellation	—	✓	✓	✓	✓	—	—
Analog (PMA) Controls Reconfiguration	✓	✓	✓	✓	✓	—	—

Table 3–5. rx_dataoutfull[31..0] FPGA Fabric-Transceiver Channel Interface Signal Descriptions (Part 3 of 3)

FPGA Fabric-Transceiver Channel Interface Description	Receive Signal Description (Based on Cyclone IV GX Supported FPGA Fabric-Transceiver Channel Interface Widths)
20-bit FPGA fabric-Transceiver Channel Interface with PCS-PMA set to 10 bits	Two 10-bit Data (rx_dataout) rx_dataoutfull[9:0] - rx_dataout (LSByte) and rx_dataoutfull[25:16] - rx_dataout (MSByte)
	wo Receiver Sync Status Bits rx_dataoutfull[10] - rx_syncstatus (LSB) and rx_dataoutfull[26] - rx_syncstatus (MSB)
	rx_dataoutfull[11] and rx_dataoutfull[27]: 8B/10B disparity error indicator (rx_disperr)
	Two Receiver Pattern Detect Bits rx_dataoutfull[12] - rx_patterndetect (LSB) and rx_dataoutfull[28] - rx_patterndetect (MSB)
	rx_dataoutfull[13] and rx_dataoutfull[29]: Rate Match FIFO deletion status indicator (rx_rmfifodatadeleted) in non-PCI Express (PIPE) functional modes
	rx_dataoutfull[14] and rx_dataoutfull[30]: Rate Match FIFO insertion status indicator (rx_rmfifodatainserted) in non-PCI Express (PIPE) functional modes
	rx_dataoutfull[15] and rx_dataoutfull[31]: 8B/10B running disparity indicator (rx_runningdisp)

Data Rate Reconfiguration Mode Using RX Local Divider

The RX local divider resides in the RX PMA block for every channels. This is a hardware feature where a /2 divider is available in each of the receiver channel for the supported device. You can use this RX local divider to reconfigure the data rate at the receiver channel. This can be used for protocols such as SDI that has data rates in divisions of 2.

By using this RX local divider, you can support two different data rates without using additional transceiver PLLs. This dynamic reconfiguration mode is available only for the receiver and not applicable to the transmitter. This reconfiguration mode using the RX local divider (/2) is only supported and available in EP4CGX30 (F484 package), EP4CGX50, and EP4CGX75 devices.

For more information about this RX local divider, refer to the *Cyclone IV GX Transceiver Architecture* chapter.

Control and Status Signals for Channel Reconfiguration

The various control and status signals involved in the Channel Reconfiguration mode are as follows. Refer to "Dynamic Reconfiguration Controller Port List" on page 3–4 for the descriptions of the control and status signals.

The following are the input control signals:

- `logical_channel_address[n..0]`
- `reset_reconfig_address`
- `reconfig_reset`
- `reconfig_mode_sel[2..0]`
- `write_all`

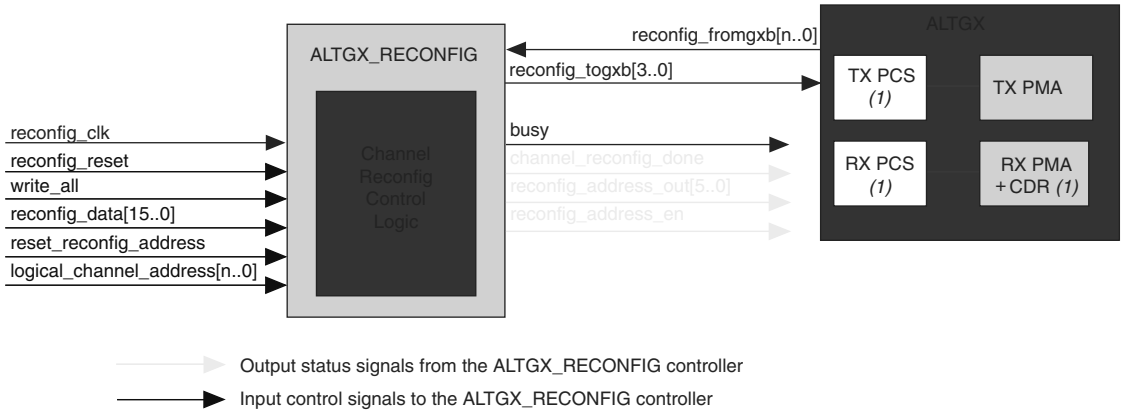
The following are output status signals:

- `reconfig_address_en`
- `reconfig_address_out[5..0]`
- `channel_reconfig_done`
- `busy`

The ALTGX_RECONFIG connection to the ALTGX instances when set in channel reconfiguration mode are as follows. For the port information, refer to "Dynamic Reconfiguration Controller Port List" on page 3–4.

Figure 3–10 shows the connection for channel reconfiguration mode.

Figure 3–10. ALTGX and ALTGX_RECONFIG Connection for Channel Reconfiguration Mode



Note to Figure 3–10:

(1) This block can be reconfigured in channel reconfiguration mode.

Section I. Device Datasheet

This section provides the Cyclone® IV device datasheet. It includes the following chapter:

- Chapter 1, Cyclone IV Device Datasheet

Revision History

Refer to each chapter for its own specific revision history. For information about when each chapter was updated, refer to the Chapter Revision Dates section, which appears in the complete handbook.

I/O Timing

Use the following methods to determine I/O timing:

- the Excel-based I/O Timing
- the Quartus II timing analyzer

The Excel-based I/O timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get a timing budget estimation as part of the link timing analysis. The Quartus II timing analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after place-and-route is complete.

The Excel-based I/O Timing spreadsheet is downloadable from Cyclone IV Devices Literature website.

Glossary

Table 1–46 lists the glossary for this chapter.

Table 1–46. Glossary (Part 1 of 5)

Letter	Term	Definitions
A	—	—
B	—	—
C	—	—
D	—	—
E	—	—
F	f_{HSCLK}	High-speed I/O block: High-speed receiver/transmitter input and output clock frequency.
G	GCLK	Input pin directly to Global Clock network.
	GCLK PLL	Input pin to Global Clock network through the PLL.
H	HSIODR	High-speed I/O block: Maximum/minimum LVDS data transfer rate (HSIODR = 1/TUI).
I	Input Waveforms for the SSTL Differential I/O Standard